

Freescale Semiconductor Addendum

MC9S08AC16AD Rev. 1, 2/2009

MC9S08AC16 Data Sheet Errata

by: Microcontroller Solutions Group

This errata document describes corrections to the *MC9S08AC16 Data Sheet*, order number 12 MC9S08AC16. For convenience, the addenda items are 12 grouped by revision. Please check our website at http://www.freescale.com for the latest updates.

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1 Errata for Revision 6

Table 1. MC9S08AC16 Rev 6 Errata

| Location | Description | | | | | |
|----------------------|--|---------------|------------|-----------|--|--|
| Throughout | Remove references to stop1 mode since that mode isn't supported on this device | | | | | |
| Table 1-1/Page 20 | Add 42 SDIP device to the Consumer and Industrial "AC" Devices section with the following details: | | | | | |
| | | Feature | MC9S08AC16 | MC9S08AC8 | | |
| | | Pin quantity | 42 | 42 | | |
| | | ADC channels | 8 | 8 | | |
| | | TPM1 channels | 4 | 4 | | |
| | | TPM2 channels | 2 | 2 | | |
| | | TPM3 channels | 2 | 2 | | |
| | | KBI pins | 6 | 6 | | |
| | | GPIO pins | 32 | 32 | | |
| Page 27 | □ = Not available on 32-, 42-, or 44-pin packages ○ = Not available on 32- or 42-pin packages △ = Not available on 32-pin packages ◇ = Not available on MC9S08AWxxA devices | | | | | |
| 1 490 27 | Add Figure # cross-reference to first sentence and add figure title under 42-Pin SDIP package. | | | | | |
| Table 4-1/Page 42 | In TPM3 overflow entry, row 3, change address from "0xFFC6:0xFFC" to "0xFFC6:0xFFC7" | | | | | |
| Table 4-2/Page 44 | In row 0x001E, change "KBEDG7" to "0" as KBIP7 does not exist on this device In row 0x001F, change "KBIPE7" to "0" as KBIP7 does not exist on this device | | | | | |
| Page 81 | Change second sentence from "which include a total of 54 general-purpose I/O pins." to "which include a total of 38 general-purpose I/O pins." | | | | | |
| Figure 8-2/Page 132 | Change legend to the following: □ = Not available on 32-, 42-, or 44-pin packages ○ = Not available on 32- or 42-pin packages △ = Not available on 32-pin packages ◇ = Not available on MC9S08AW<i>xx</i>A devices | | | | | |
| Section 9.2/Page 159 | First paragraph, remove second sentence. Second paragraph, remove second sentence. Third paragraph, change KBIP7 to KBIP6. | | | | | |
| Section 9.3/Page 159 | Change second buillet from "Four falling edge/low level or" to "Three falling edge/low level or" | | | | | |
| Figure 9-1/Page 160 | Change legend to the following: ☐ = Not available on 32-, 42-, or 44-pin packages O = Not available on 32- or 42-pin packages ▲ = Not available on 32-pin packages ◆ = Not available on MC9S08AW <i>xx</i> A devices | | | | | |



| Table 1. MC9S08AC16 F | ev 6 Errata (continued) |
|-----------------------|-------------------------|
|-----------------------|-------------------------|

| Location | Description |
|----------------------|---|
| Figure 10-1/Page 167 | Change legend to the following: □ = Not available on 32-, 42-, or 44-pin packages ○ = Not available on 32- or 42-pin packages △ = Not available on 32-pin packages ◇ = Not available on MC9S08AWxxA devices |
| Figure 11-1/Page 198 | Change legend to the following: □ = Not available on 32-, 42-, or 44-pin packages ○ = Not available on 32- or 42-pin packages △ = Not available on 32-pin packages ◇ = Not available on MC9S08AWxxA devices |
| Figure 12-1/Page 218 | Change legend to the following: □ = Not available on 32-, 42-, or 44-pin packages ○ = Not available on 32- or 42-pin packages ▲ = Not available on 32-pin packages ◆ = Not available on MC9S08AWxxA devices |
| Figure 13-1/Page 234 | Change legend to the following: □ = Not available on 32-, 42-, or 44-pin packages ○ = Not available on 32- or 42-pin packages △ = Not available on 32-pin packages ◇ = Not available on MC9S08AWxxA devices |
| Figure 14-1/Page 255 | Change legend to the following: □ = Not available on 32-, 42-, or 44-pin packages ○ = Not available on 32- or 42-pin packages ▲ = Not available on 32-pin packages ♦ = Not available on MC9S08AWxxA devices |



| Location | | Description | | | | | | |
|--|--|-----------------------|---|---------------|--------|---------------------------|------|------|
| Page 288 | Add the following DC injection current specifications to the end of the DC Characteristics table. | | | | | | | |
| | Num | С | Parameter | Symbol | Min | Тур | Max | Unit |
| | 20 | D | DC injection current ^{1, 2, 3, 4} | | | | | |
| | | | Single pin limit | | | | | |
| | | | $V_{IN} > V_{DD}$ | | 0 | — | 2 | mA |
| | | | $V_{IN} < V_{SS}$ | _C | 0 | | -0.2 | mA |
| | | | Total MCU limit, includes sum or stressed pins | - | | | | |
| | | | $V_{IN} > V_{DD}$ | | 0 | | 25 | mA |
| | | | V _{IN} < V _{SS} | | 0 | | -5 | mA |
| Table A-3/Page 305 | greatest risk when the MCU is not consuming power. Examples are: if r clock is present, or if clock rate is very low which (would reduce overall consumption). ² All functional non-supply pins are internally clamped to V_{SS} and V_{DD}. ³ Input must be current limited to the value specified. To determine the varequired current-limiting resistor, calculate resistance values for positive negative clamp voltages, then use the larger of the two values. ⁴ IRQ does not have a clamp diode to V_{DD}. Do not drive IRQ above V_{DD}. | | | | | l powe alue o e and | r | |
| | | | Rating Syr | mbol Val | ue | Uni | it | |
| | | | 42-pin SDIP 1s | 58 | | | | |
| | | | | JA 4 | | °C/\ | N | |
| | | | | | 1 | | | |
| Table A-6/Page 307 Move VOL (#2) specifications from Min column to Max column. Min columns | | | shoul | d be "- | | | | |
| Figure A-12/Page 321 | Change | Change KBIP7 to KBIP6 | | | | | | |
| Table B-1/Page 327 | Remove | • "42- | pin SDIP" from Available Packages i | in Automotive | Qualif | icatior | row | |

Table 1. MC9S08AC16 Rev 6 Errata (continued)



2 Revision History

Table 2 provides a revision history for this document.

Table 2. MC9S08AC16AD Revision History

| Rev. Number | Substantive Changes | Date of Release |
|-------------|---|-----------------|
| 0 | Initial release | 10/2008 |
| 1 | Added errata for the following sections: • Throughout (remove stop1 instances) • Table 4-1/Page 42 • Table 4-2/Page 44 • Section 9.2/Page 159 • Section 9.3/Page 159 • Table A-6/Page 307 • Figure A-12/Page 321 | 2/2009 |



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Freescale Semiconductor, Inc. Technical Information Center, EL516 2100 East Elliot Road Tempe, Arizona 85284 +1-800-521-6274 or +1-480-768-2130 www.freescale.com/support

Europe, Middle East, and Africa:

Freescale Halbleiter Deutschland GmbH Technical Information Center Schatzbogen 7 81829 Muenchen, Germany +44 1296 380 456 (English) +46 8 52200080 (English) +49 89 92103 559 (German) +33 1 69 35 48 48 (French) www.freescale.com/support

Japan:

Freescale Semiconductor Japan Ltd. Headquarters ARCO Tower 15F 1-8-1, Shimo-Meguro, Meguro-ku, Tokyo 153-0064 Japan 0120 191014 or +81 3 5437 9125 support.japan@freescale.com

Asia/Pacific:

Freescale Semiconductor Hong Kong Ltd. Technical Information Center 2 Dai King Street Tai Po Industrial Estate Tai Po, N.T., Hong Kong +800 2666 8080 support.asia@freescale.com

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